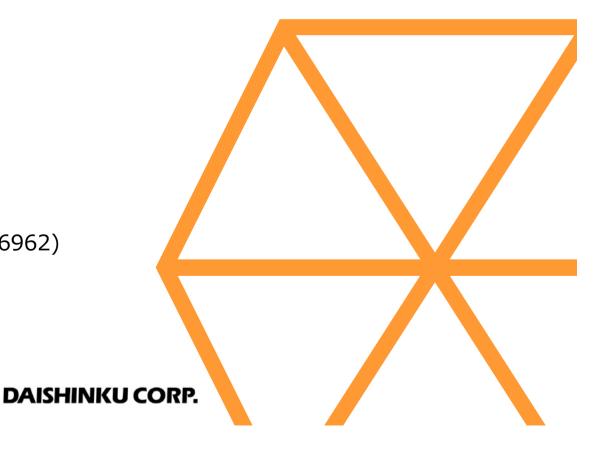


# **Financial results briefing**

#### Financial Results for the 2Q of Fiscal Year Ending March 31, 2022

November 30, 2021 DAISHINKU CORP. (Code: 6962) President, Minoru Iizuka





Unit : Million yen

#### Performance Report for the 2Q of Fiscal Year Ending March 31, 2022

## **Record-high profit**

USD average rate(yen)

	2Q of Fiscal	2Q of Fiscal	YoY Change	
	Year Ended	Year Ending		
	March 31, 2021	March 31, 2022		
Net sales	14,463	21,434	+6,971 1	+48.2%
Operating income	474	2,762	+2,288 1	+481.7%
Ordinary income	433	3,042	+2,609 1	+602.4%
Profit attributable to owners of parent	105	1,773	+1,668 1	+1,578.9%

#### DAISHINKU CORP.

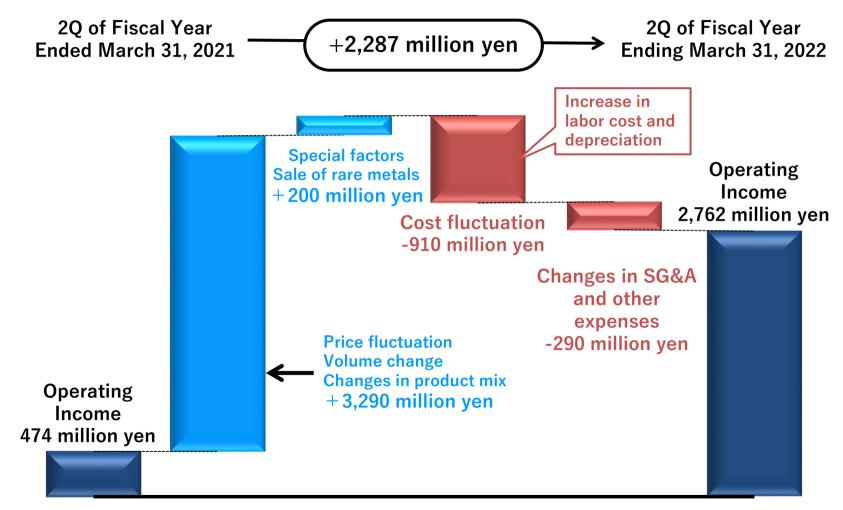
+106.93yen

+109.81yen

+2.88yen 1



# **Operating Income Analysis (YoY Change)**





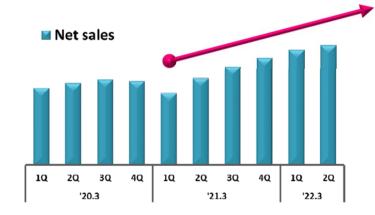
# **Quarterly Performance Report**

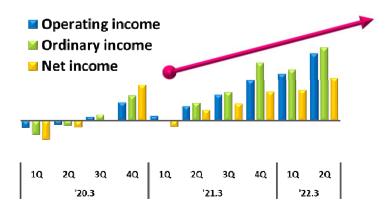
## **Record-high profit**

Sales and profit increased for five consecutive quarters. (Operating income/Net income rose consecutively.)

			Unit :	Million yen
	Fiscal Year Ending March 31, 2022	Fiscal Year Ending March 31, 2022	QoQ Change	
	AprJun.	JulSep.		
Net sales	10,507	10,927	+420 1	+4.0%
Operating income	1,137	1,625	+488 1	+42.9%
Ordinary income	1,234	1,808	+574 1	+46.3%
Profit attributable to owners of parent	740	1,033	+293 1	+39.5%

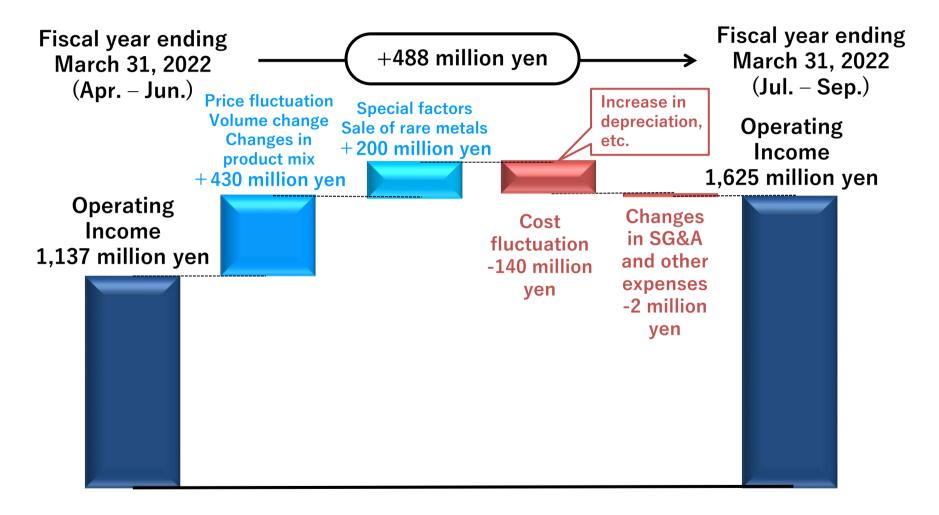
USD average rate(yen) +109.52yen +110.11yen +0.59yen ↑	-
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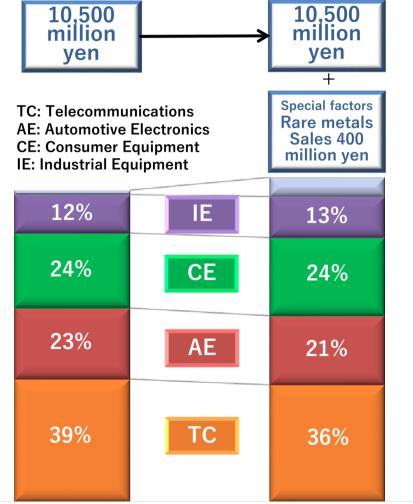


# **Operating Income Analysis (QoQ Change)**





# Sales by Application (QoQ Change)



Apr.-Jun. Jul.-Sep. Fiscal Year Ending March 31, 2022

#### QoQ Change +6%

• Increased demand for FA/robot and housing-related applications.

CE

IE

#### QoQ Change +4%

• Continued strong sales of PCrelated equipment and tablet devices.

AE

#### **QoQ Change -2%**

• Sales for ADAS and electrification advanced although semiconductor shortages affected some regions.

#### TC QoQ Change -5%

**%Breakdown of net sales** 



# Capital Expenditures / Depreciation / R&D Expenses

YoY			
	2Q of Fiscal Year	2Q of Fiscal Year	Unit : Million yen
	Ended March 31, 2021	Ending March 31, 2022	Change
Capital Expenditure	2,153	2,666	+513 1
Depreciatio	on 1,374	1,659	+285 1
R&D Expens	ses 1,030	1,042	+12 1

#### Major CAPEX

Photolithography-related facilities (wafers/assembly enhancement, development) Production facilities for ultra-low-profile crystal oscillator Harmony Electronics' second factory in Thailand

#### QoQ

	Fiscal Year Ending March 31, 2022 AprJun.	Fiscal Year Ending March 31, 2022 JulSep.	Change
Capital Expenditures	1,424	1,242	-182 ↓
Depreciation	810	849	+39 ↑
R&D Expenses	520	522	+2 1

#### Major R&D

Next-generation crystal device at higher frequencies Arkh series Larger raw crystal Larger wafer size



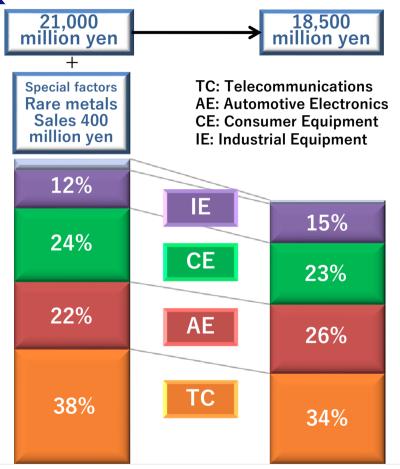
# **Full Year Forecast**

Unit : Million yen

Цру	ard revision	Fiscal Year	Fiscal Year Ending March 31, 2022		
Opw		Ended March 31, 2021	1st Half results	2nd Half forecasts	Full-year forecasts
	Net sales	33,189	21,434	18,566	40,000
	Operating income	2,089	2,762	2,038	4,800
	Ordinary income	2,533	3,042	1,958	5,000
	Profit attributable to owners of parent	1,223	1,773	627	2,400
	USD average rate(yen)	106.10yen	109.81yen	110.00yen	
	Capital Expenditures	4,355	2,666	6,334	9,000
	Depreciation	2,921	1,659	1,941	3,600
	R&D Expenses	2,048	1,042	1,358	2,400



## Market Overview (1st Half Results vs. 2nd Half Forecast)



1st Half 2nd Half Fiscal Year Ending March 31, 2022 IE HoH Change +3%

• Sales remained at a steady level (as in the first half).

CE

AE

HoH Change -17%

• Influenced by semiconductor shortages and seasonal factors.

HoH Change +2%

 Continued progress in ADAS applications and electrification.

TC HoH Change -21%

• Affected by semiconductor shortages.

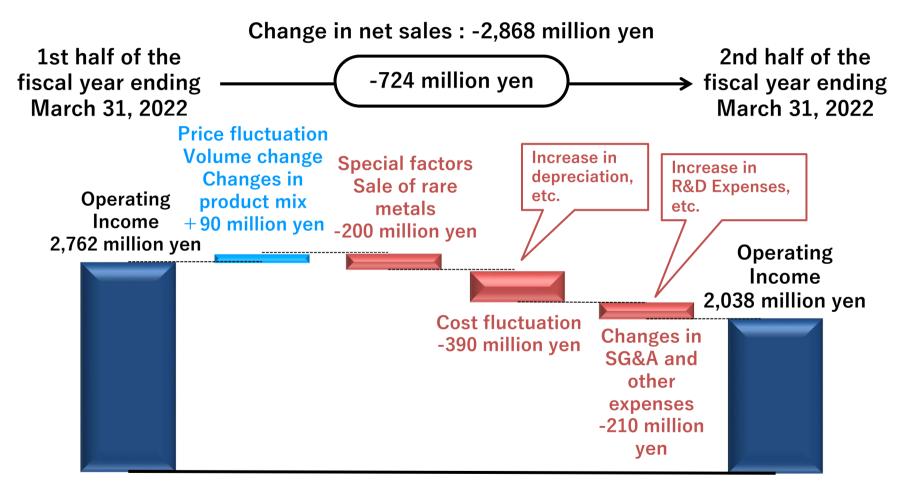
**%Change in absolute amount** 

**%Breakdown of net sales** 

The forecast remains unchanged and we have focused on the 1st Half from the beginning<br/>of the fiscal year.9 /22



# Operating Income Analysis (1st Half Results vs. 2nd Half Forecast)





## **Progress of 1st MTMP** \*1st MTMP: Established by DAISHINKU in 2021



### 1st MTMP has been carried out ahead of schedule. Aiming to achieve early achievement of Year 2 of MTMP.

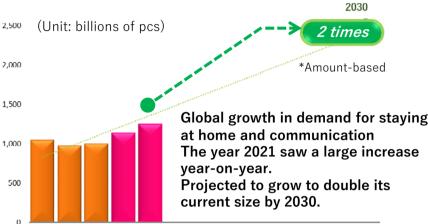
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# **Reasons for Moving Up**

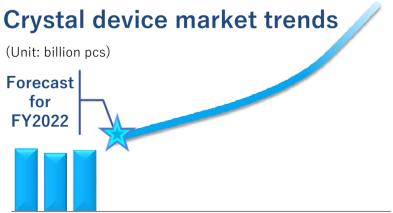
Forecast for

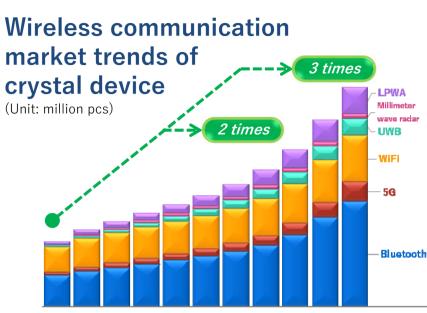
# Semiconductor market trends



FY2018 FY2019 FY2020 FY2021 FY2022 FY2023 FY2024 FY2025 FY2026 FY2027 FY2028 FY2029 FY2030

\*Based on information from IC Insight, WSTS, METI, and other sources (Estimated by DAISHINKU)





FY2020FY2021FY2022FY2023FY2024FY2025FY2026FY2027FY2028FY2029FY2030

\*Based on information from Fuji Chimera and Techno Systems Research (Estimated by DAISHINKU)

5G · WiFi · Bluetooth Massive volume increase For 5G/WiFi →MHz-band crystal resonator (photolithography) For IoT in general →kHz-band crystal resonator (photolithography) For IoT in general →MHz-band crystal resonator

FY2018 FY2019 FY2020 FY2021 FY2022 FY2023 FY2024 FY2025 FY2026 FY2027 FY2028 FY2029 FY2030

\*Based on data from Quartz Crystal Industry Association of Japan (Estimated by DAISHINKU)



## Addressing Volume Increase [Approach to Existing Products]

Crystal device for 5G, WiFi and IoT in general

DATOT

MHz-band crystal resonator (photolithography)

kHz-band crystal resonator (photolithography)

MHz-band crystal resonator

Output maximization and environmental friendliness through innovation in production facilities

"Flexible & Fully Automatic" production line under development

Target (vs. traditional system):

Equipment capacity (about **2.5** times), its area (approx. **50**%)

Output About 5 times (No floor space increase)

#### Robot verification system for complete automation

- Multi-articulated robot
- Self-propelled robot



13 /22



## Addressing Volume Increase [Approach to Product Development]

**Existing model** Externally procured parts: Lid, Base, IC, Thermistor Ceramic package applications \*Can be sealed hermetically Externally procured \* Required for high-precision devices **Difficulty in procuring** parts share parts and materials **MEMS** sensors/Image sensors due to rapid increase 約70% **Optical communication module** in demand Package for semiconductor Package for crystal device What we do Arkh.3G Arkh.4G **Molded Oscillator Creating an** environmentally sustainable society **Externally procured Expanding mold Resin film** technology to crystal parts share Adhesive-free **SDGs Direct material** Lead time % cost reduction reduction



# **New Development of Arkh Series** Fusion of Arkh.Series + resin mold

#### **Molded resin products**

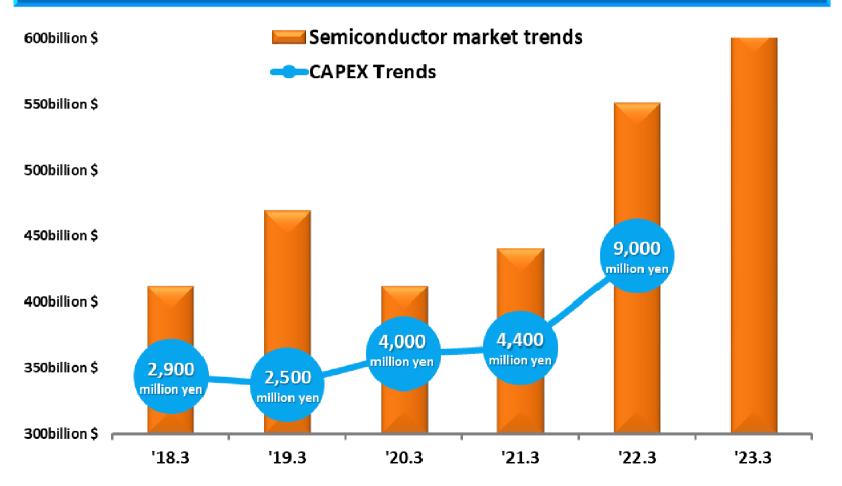


- Traditional ICs are changing from ceramic to molded.
- Crystals cannot normally be molded, but the built-in Arkh series makes this possible.



# **CAPEX Trends**

Planning to invest 9,000 million yen in the fiscal year ending March 2022 to prepare for market expansion

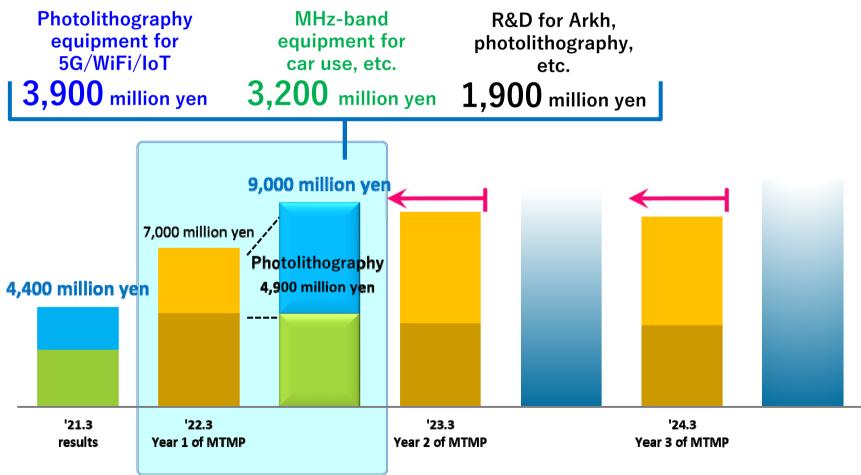


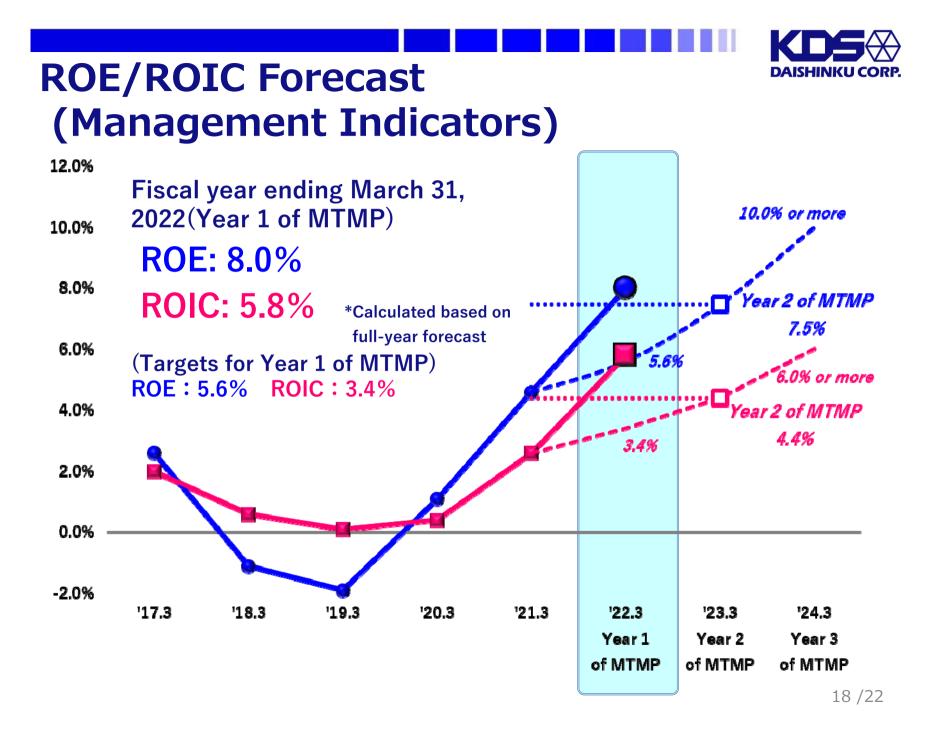


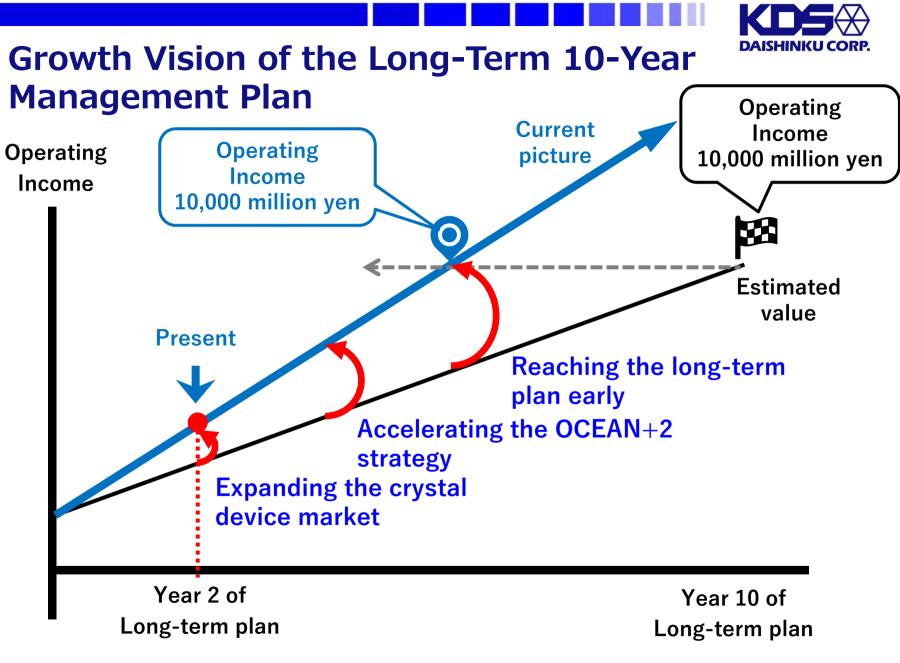
# **CAPEX Plan for FY2022**

Increased from the initial plan of 7,000 million yen to

## 9,000 million yen

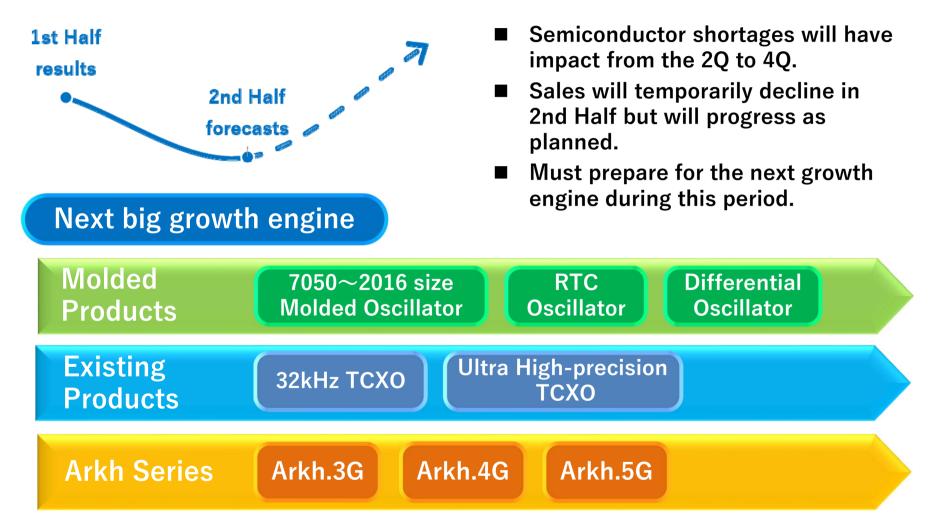






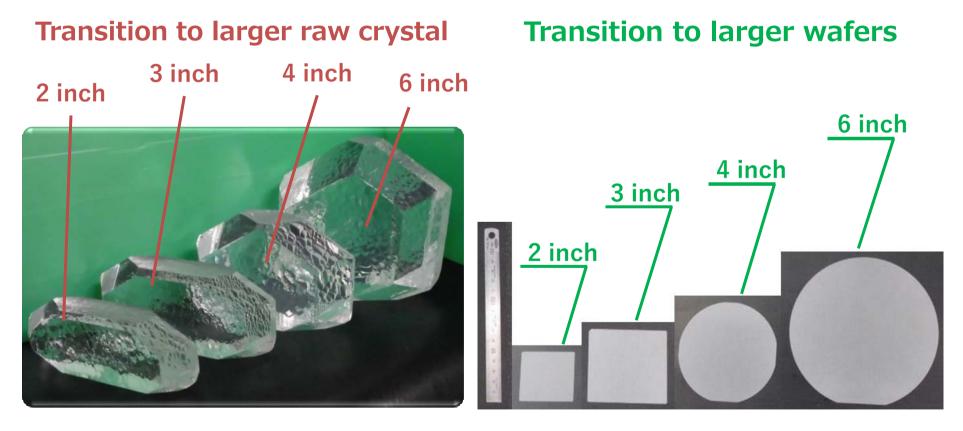


## **Outlook for the Current Fiscal Year and Preparation for the Next Fiscal Year**



# **Future Crystal Industry: Sources of Growth**

## Large wafers are essential for growth engines; no optimization is possible with small-size wafers.







# "Reliance" is the policy we offer all our customers worldwide.